



General Description

The NTMFS4C09NT1G use advanced SGT MOSFET technology to provide low RDS(ON), low gate charge, fast switching and excellent avalanche characteristics. This device is specially designed to get better ruggedness.

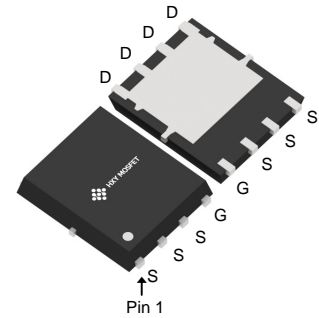
General Features

$V_{DS} = 30V$ $I_D = 60A$

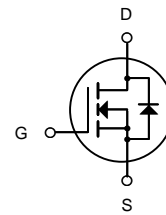
$R_{DS(ON)} < 5.8m\Omega @ V_{GS}=10V$

Applications

Consumer electronic power supply Motor control
Synchronous-rectification Isolated DC
Synchronous-rectification applications



DFN5X6-8L
(SO-8-FL-5.9mm)



N-Channel MOSFET

Ordering Information

| Product ID | Pack | Brand | Qty(PCS) |
|---------------|--------------------------|------------|----------|
| NTMFS4C09NT1G | DFN5X6-8L(SO-8-FL-5.9mm) | HXY MOSFET | 5000 |

Absolute Maximum Ratings ($T_c=25^\circ C$ unless otherwise noted)

| Symbol | Parameter | Rating | Units |
|-------------------------|--|------------|--------------|
| V_{DS} | Drain-Source Voltage | 30 | V |
| V_{GS} | Gate-Source Voltage | ± 20 | V |
| $I_D @ T_c=25^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V$ | 60 | A |
| $I_D @ T_c=100^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V$ | 38 | A |
| I_{DM} | Pulsed Drain Current ² | 135 | A |
| EAS | Single Pulse Avalanche Energy ³ | 29.8 | mJ |
| $P_D @ T_c=25^\circ C$ | Total Power Dissipation ⁴ | 30 | W |
| T_{STG} | Storage Temperature Range | -55 to 150 | $^\circ C$ |
| T_J | Operating Junction Temperature Range | -55 to 150 | $^\circ C$ |
| $R_{\theta JC}$ | Thermal Resistance from Junction-to-Ambient ³ | 4.6 | $^\circ C/W$ |
| $R_{\theta JA}$ | Thermal Resistance Junction-Ambient ¹ | 50 | $^\circ C/W$ |



Electrical Characteristics (T_J= 25°C, unless otherwise noted)

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|---------------------|--|---|------|------|------|------|
| BV _{DSS} | Drain-Source Breakdown Voltage | V _{GS} =0V , I _D =250uA | 30 | --- | --- | V |
| R _{DS(ON)} | Static Drain-Source On-Resistance ² | V _{GS} =10V , I _D =20A | --- | 4.4 | 5.8 | mΩ |
| | | V _{GS} =4.5V , I _D =15A | --- | 6.9 | 9 | |
| V _{GS(th)} | Gate Threshold Voltage | V _{GS} =V _{DS} , I _D =250uA | 1.2 | --- | 2.5 | V |
| I _{DSS} | Drain-Source Leakage Current | V _{DS} =24V , V _{GS} =0V , T _J =25°C | --- | --- | 1 | uA |
| | | V _{DS} =24V , V _{GS} =0V , T _J =55°C | --- | --- | 5 | |
| I _{GSS} | Gate-Source Leakage Current | V _{GS} =±20V , V _{DS} =0V | --- | --- | ±100 | nA |
| g _{fs} | Forward Transconductance | V _{DS} =5V , I _D =20A | --- | 67 | --- | S |
| R _g | Gate Resistance | V _{DS} =0V , V _{GS} =0V , f=1MHz | --- | 1.7 | --- | Ω |
| Q _g | Total Gate Charge (4.5V) | V _{DS} =15V , V _{GS} =4.5V , I _D =15A | --- | 8 | --- | nC |
| Q _{gs} | Gate-Source Charge | | --- | 2.4 | --- | |
| Q _{gd} | Gate-Drain Charge | | --- | 3.2 | --- | |
| T _{d(on)} | Turn-On Delay Time | V _{DD} =15V , V _{GS} =10V , R _G =3.3Ω I _D =15A | --- | 7.1 | --- | ns |
| T _r | Rise Time | | --- | 40 | --- | |
| T _{d(off)} | Turn-Off Delay Time | | --- | 15 | --- | |
| T _f | Fall Time | | --- | 6 | --- | |
| C _{iss} | Input Capacitance | V _{DS} =15V , V _{GS} =0V , f=1MHz | --- | 814 | --- | pF |
| C _{oss} | Output Capacitance | | --- | 498 | --- | |
| C _{rss} | Reverse Transfer Capacitance | | --- | 41 | --- | |
| I _S | Continuous Source Current ^{1,6} | V _G =V _D =0V , Force Current | --- | --- | 60 | A |
| V _{SD} | Diode Forward Voltage ² | V _{GS} =0V , I _S =1A , T _J =25°C | --- | --- | 1 | V |
| t _{rr} | Reverse Recovery Time | I _F =20A , di/dt=100A/μs , | --- | 15 | --- | nS |
| Q _{rr} | Reverse Recovery Charge | T _J =25°C | --- | 25 | --- | nC |

Note :

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%
- 3.The EAS data shows Max. rating . The test condition is V_{DD}=25V,V_{GS}=10V,L=0.1mH,I_{AS}=24A
- 4.The power dissipation is limited by 150°C junction temperature
- 5.The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.



Typical Characteristics



Fig.1 Typical Output Characteristics

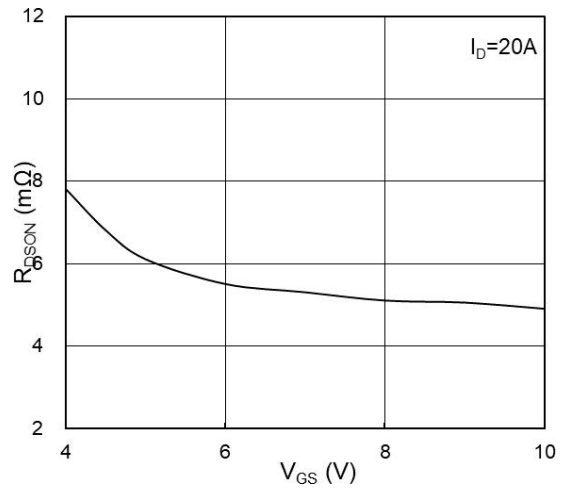


Fig.2 On-Resistance vs G-S Voltage

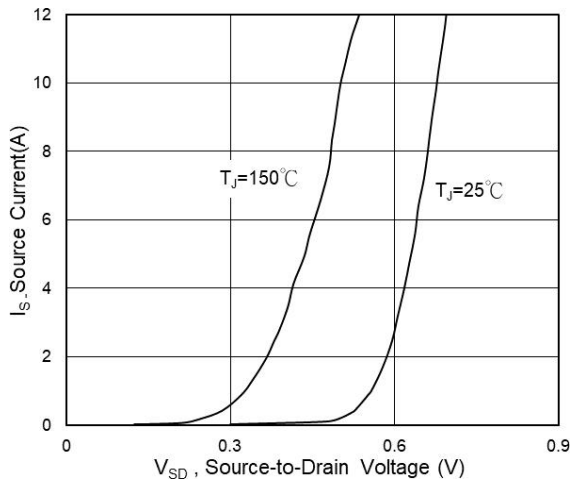


Fig.3 Source Drain Forward Characteristics

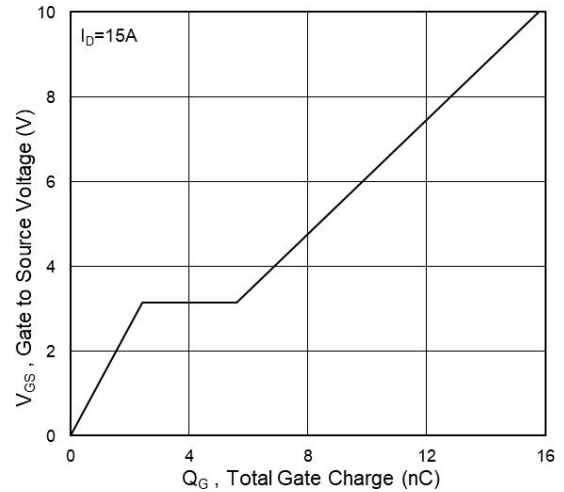


Fig.4 Gate-Charge Characteristics

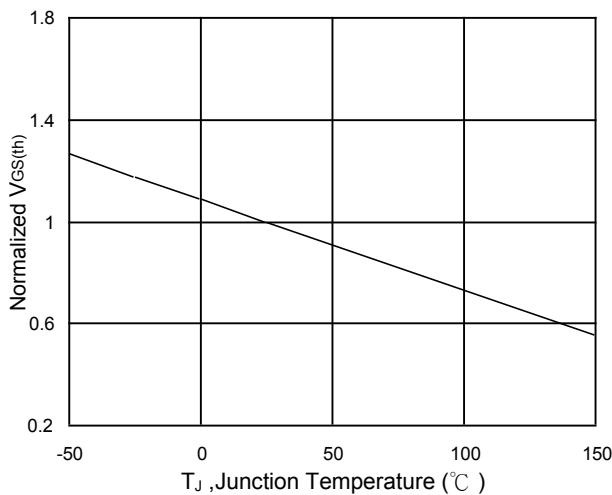


Fig.5 Normalized $V_{GS(th)}$ vs T_J

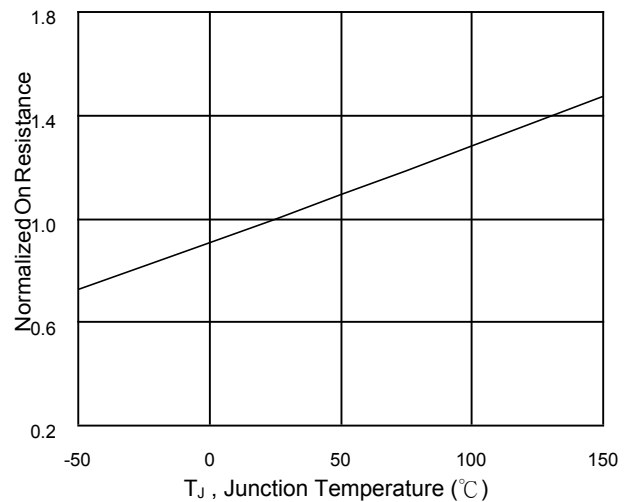


Fig.6 Normalized $R_{DS(on)}$ vs T_J

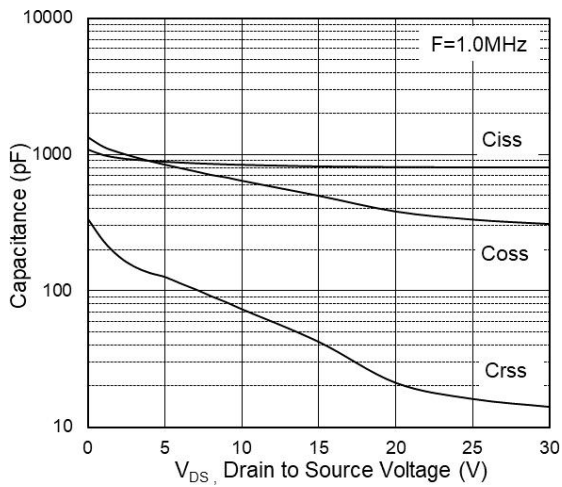


Fig.7 Capacitance

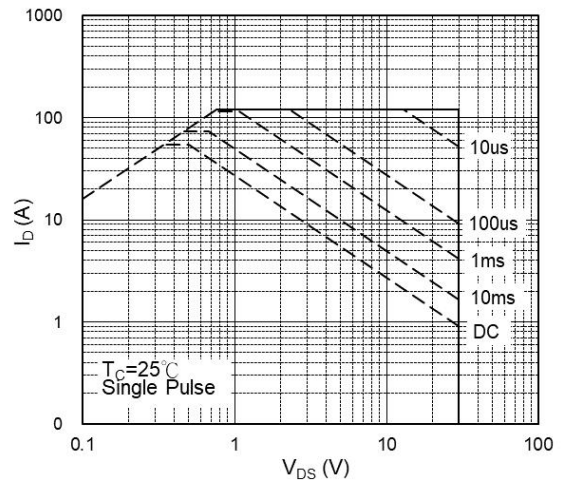


Fig.8 Safe Operating Area

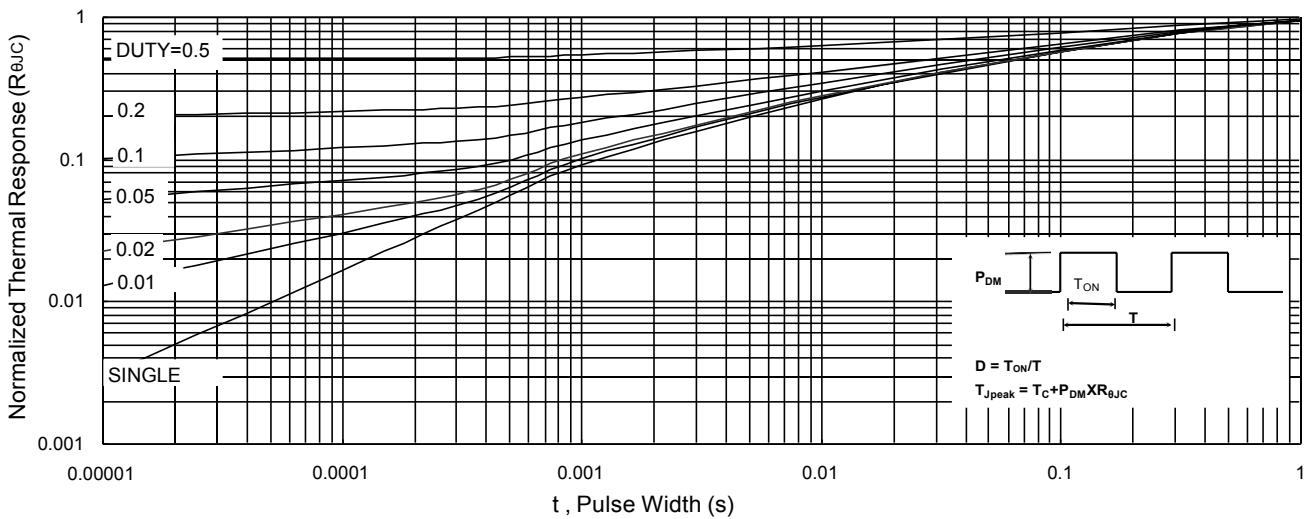


Fig.9 Normalized Maximum Transient Thermal Impedance



Fig.10 Switching Time Waveform

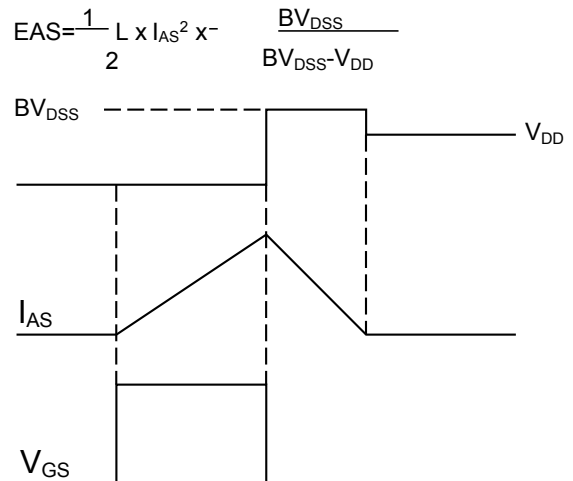
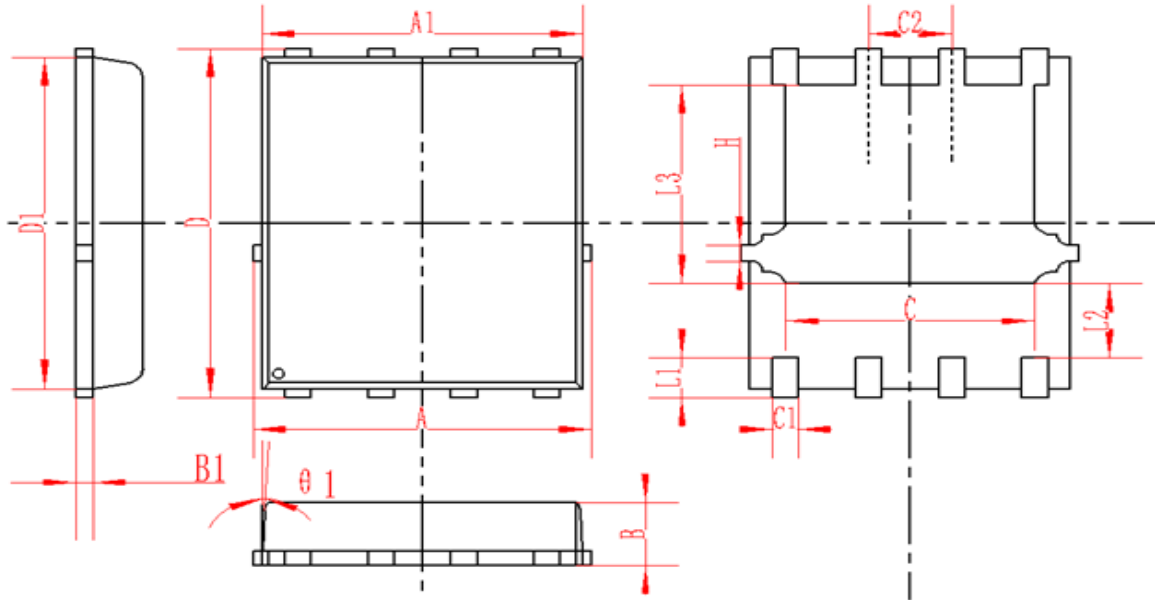


Fig.11 Unclamped Inductive Switching Waveform



DFN5X6-8L(SO-8-FL-5.9mm)Package Information



| SYMBOL | MM | | | INCH | | |
|--------|----------|------|-------|----------|-------|-------|
| | MIN | NOM | MAX | MIN | NOM | MAX |
| A | 4.95 | 5 | 5.05 | 0.195 | 0.197 | 0.199 |
| A1 | 4.82 | 4.9 | 4.98 | 0.190 | 0.193 | 0.196 |
| D | 5.98 | 6 | 6.02 | 0.235 | 0.236 | 0.237 |
| D1 | 5.67 | 5.75 | 5.83 | 0.223 | 0.226 | 0.230 |
| B | 0.9 | 0.95 | 1 | 0.035 | 0.037 | 0.039 |
| B1 | 0.254REF | | | 0.010REF | | |
| C | 3.95 | 4 | 4.05 | 0.156 | 0.157 | 0.159 |
| C1 | 0.35 | 0.4 | 0.45 | 0.014 | 0.016 | 0.018 |
| C2 | 1.27TYP | | | 0.5TYP | | |
| θ1 | 8° | 10° | 12° | 8° | 10° | 12° |
| L1 | 0.63 | 0.64 | 0.65 | 0.025 | 0.025 | 0.026 |
| L2 | 1.2 | 1.3 | 1.4 | 0.047 | 0.051 | 0.055 |
| L3 | 3.415 | 3.42 | 3.425 | 0.134 | 0.135 | 0.135 |
| H | 0.24 | 0.25 | 0.26 | 0.009 | 0.010 | 0.010 |



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